

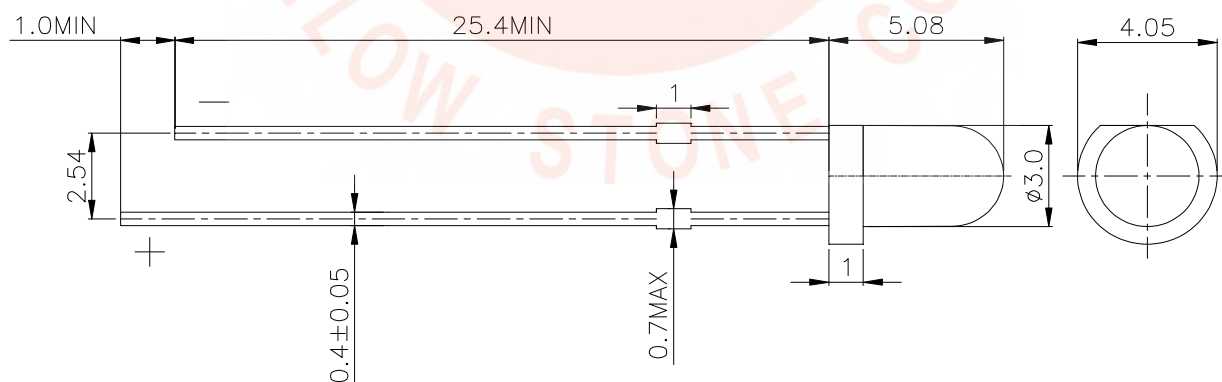
◆Features

- I 3mm Rounded LED Lamps
- I Emitting Color: Green
- I Lens Color: Water Clear
- I Material: InGaN
- I Low power consumption
- I Excellent product quality and reliability
- I Lead-free device

◆Applications

- I Electronic signs and signals
- I Bright ambient lighting conditions
- I Backlight
- I General purpose indicators

◆ Package Dimensions



Notes:

1. All dimensions are in millimeters.
2. Tolerance is  $\pm 0.25$  unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. Specifications are subject to change without notice.
5. The design and working Current for Led is not less than 2mA.

### ◆ Absolute Maximum Ratings at TA=25°C

| Parameter               | Symbol | Value               | Unit |
|-------------------------|--------|---------------------|------|
| Power Dissipation       | PD     | 100                 | mW   |
| Forward Current         | IF     | 30                  | mA   |
| Peak Forward Current*1  | IFP    | 100                 | mA   |
| Reverse Voltage         | VR     | 5                   | V    |
| Operating Temperature   | Topr   | -40°C To +85°C      |      |
| Storage Temperature     | Tstg   | -40°C To +85°C      |      |
| Soldering Temperature*2 | Tsol   | 260°C For 5 Seconds |      |

Notes:

\*1: Pulse width≤0.1ms, Duty cycle≤1/10

\*2: ΔAt the position of 3mm below package base.

\*3: ▲Plese refer to the curve of forward current vs.temperature

### ◆ Electrical / Optical Characteristics at TA=25°C

| Parameter                | Symbol | Min. | Typ. | Max   | Unit | Test Conditions |
|--------------------------|--------|------|------|-------|------|-----------------|
| Forward Voltage          | VF     | 2.2  | 2.5  | 2.8   | V    | IF=5mA          |
| Reverse Current          | IR     | —    | —    | 10    | μA   | VR=5V           |
| Dominant Wavelength      | λd     | 530  | 535  | 540   | nm   | IF=5mA          |
| Peak Wavelength          | λP     | —    | 530  | —     | nm   | IF=5mA          |
| Spectral line Half-width | Δλ     | —    | 30   | —     | nm   | IF=5mA          |
| Luminous Intensity       | IV     | 4200 | 8000 | 14000 | mcd  | IF=5mA          |
| Power Angle              | 2θ1/2  | —    | 25   | —     | Deg. | IF=5mA          |

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or dominant wavelength), the typical accuracy of the sorting process is as follows:

1. Dominant Wavelength: +/-1nm
2. Chromatic Coordinates: +/-0.01
3. Luminous Intensity: +/-15%
4. Forward Voltage: +/-0.1V

◆ VF Rank

| Rank | VF(V) |     | Condition |
|------|-------|-----|-----------|
|      | Min   | Max |           |
| F1   | 2.2   | 2.4 | IF=5mA    |
| G1   | 2.4   | 2.6 |           |
| H1   | 2.6   | 2.8 |           |

Tolerance:±0.1V

◆ λD Rank

| Rank | λD(nm) |     | Condition |
|------|--------|-----|-----------|
|      | Min    | Max |           |
| G1   | 525    | 530 | IF=5mA    |
| G2   | 530    | 535 |           |

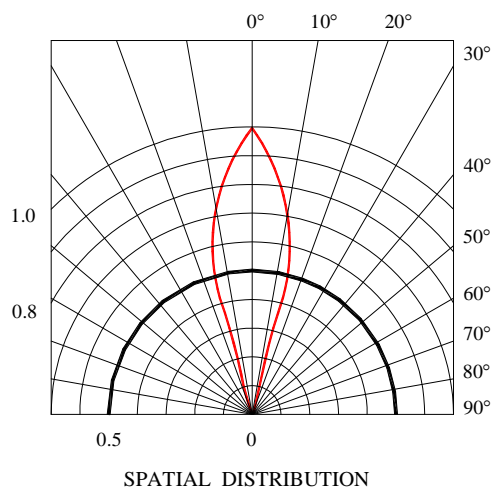
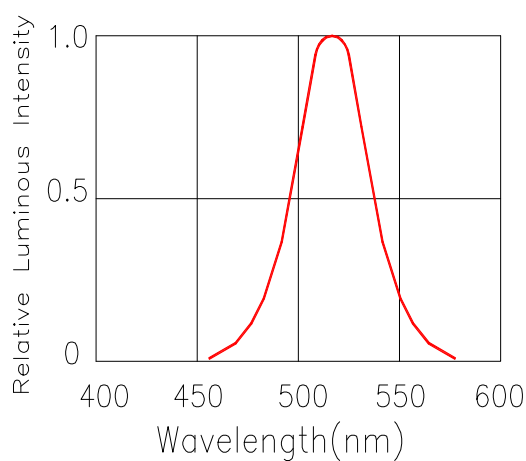
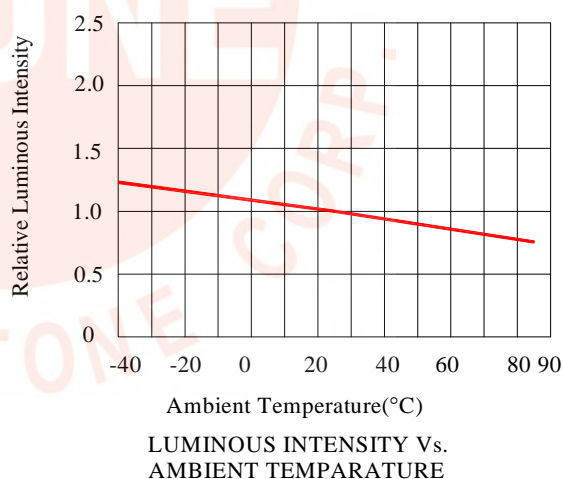
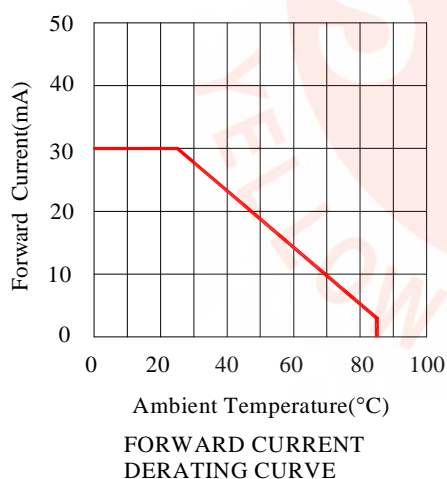
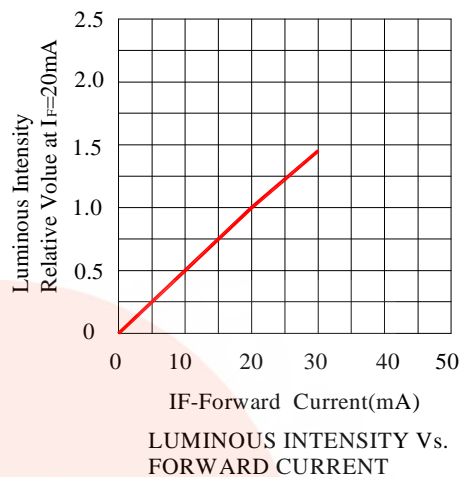
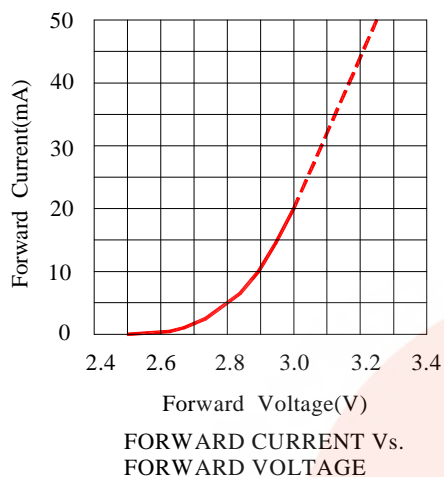
Tolerance:±1nm

◆ IV Rank

| Rank | IV(mcd) |       | Condition |
|------|---------|-------|-----------|
|      | Min     | Max   |           |
| R    | 4200    | 6300  | IF=5mA    |
| S    | 6300    | 9500  |           |
| T    | 9500    | 14000 |           |

Tolerance:±15%

◆ **Typical Electrical/Optical Characteristics Curves**  
 (  $T_a=25^{\circ}\text{C}$  Unless Otherwise Noted )



### ◆ Reliability Test Items and Conditions

| Test Classification | Test Item                               | Test Conditions                              | Test Duration | Sample Size | AC/RE |
|---------------------|---|--|---------------|-------------|-------|
| Life Test           | Room Temperature DC Operating Life Test | Ta=25°C±5°C,<br>If=20mA                      | 1000hrs       | 22pcs       | 0/1   |
| Environment Test    | Thermal Shock Test                      | 100°C±5°C 15min<br>↓↑<br>-40°C±5°C 15min     | 20 cycles     | 22pcs       | 0/1   |
|                     | Temperature Cycle Test                  | 100°C±5°C 30min<br>↓↑5min<br>-40°C±5°C 30min | 20 cycles     | 22pcs       | 0/1   |
|                     | High Temperature & High Humidity Test   | 85°C±5°C /85% RH                             | 1000hrs       | 22pcs       | 0/1   |
|                     | High Temperature Storage                | Ta=100°C±5°C                                 | 1000hrs       | 22pcs       | 0/1   |
|                     | Low temperature Storage                 | Ta=-40°C±5°C                                 | 1000hrs       | 22pcs       | 0/1   |
| Mechanical Test     | Resistance to Soldering Heat            | Temp=260°C ±5°C<br>T=5s max                  | 2 times       | 22pcs       | 0/1   |

### ◆ Criteria for Judging the Damage

| Item               | Symbol   | condition | Criteria for Judgement |           |
|--------------------|----------|-----------|------------------------|-----------|
|                    |          |           | MIN.                   | MAX.      |
| Forward Voltage    | VF (V)   | IF=20mA   | ---                    | U.S.L*1.1 |
| Reverse Current    | IR (uA)  | VR=5V     | ---                    | 10uA      |
| Luminous Intensity | IV (mcd) | IF=20mA   | L.S.L*0.5              | ---       |

【Note】 1.USL: Upper Specification Level      2.LSL: Lower Specification Level

## ◆ CAUTIONS:

### 1. Lead Forming & Assembly

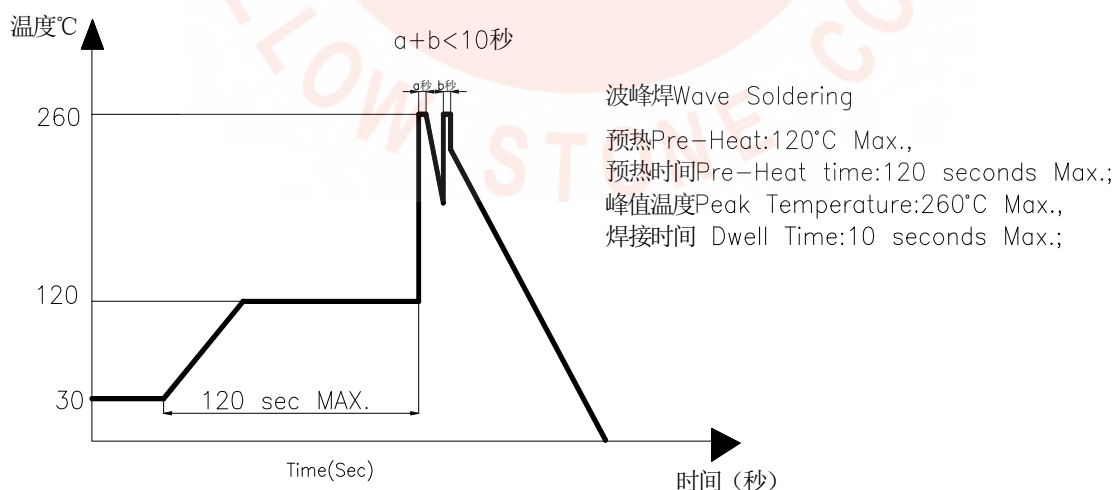
- Lead forming or bending must be done before soldering, at normal temperature.
- During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens.
- Do not use the base of the lead frame as a fulcrum during lead forming.
- Avoid bending the leads at the same point more than once.
- During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

### 2. LED Mounting Method

- The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch.
- When soldering wire to the LED. Use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit.
- Use stand-offs or spacers to securely position the LED above the PCB.

### 3. Soldering

- When soldering, the soldering iron needs to be at least 3mm away from the epoxy edge. After soldering, allow at least 3 minutes for LEDs to cool back to normal temperature. DO not apply any pressure to the epoxy encapsulation or the lead frame during the soldering process.



- When using soldering iron, please solder once for less than 5 seconds at a maximum Temperature of 300°C. When soldering a row of LED on a PCB. Please do not solder both Leads of a LED in sequence. (Solder all the positive lead first, then all the negative leads).
- Do not dip the epoxy encapsulation part of LED into any soldering paste liquid.
- After soldering, do not adjust the location of the LED anymore.

- When attaching electronic parts to a PCB with LEDs .the curing time for the whole PCB

Should be less than 60 seconds .at less than a temperature of 120°C.

#### **4.Cleaning:**

- Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

#### **5.Storage**

- The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity.
- It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

#### **6.ESD ( Electrostatic Discharge)**

Static Electricity or power surge will damage the LED.

Suggestions to prevent of ESD damage.

- All devices, equipment, and machinery must be properly grounded.
- Use a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- Maintain a humidity level of 50% or higher in production areas.
- Use anti-static packaging for transportation and storage.

#### **7.Recommended Usage Guidelines**

- Please only use 20mA(Lamp LED) of forward current to drive LEDs whether one LED or multiple LEDs are being used.
- Sudden surge could damage the LED interior connections.please design circuit with care to no sudden voltage surge or current surge will show when turning the circuit on or off.